

## **MOSFET**

### OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V

#### **Features**

- Optimized for synchronous rectification
- 100% avalanche testedSuperior thermal resistance
- N-channel, normal level
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

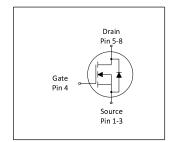
#### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

**Key Performance Parameters** Table 1

Parameter	Value	Unit
$V_{ extsf{DS}}$	60	V
R <sub>DS(on),max</sub>	3.0	mΩ
I <sub>D</sub>	137	A
Q <sub>oss</sub>	42	nC
Q <sub>G</sub> (0V10V)	39	nC











Type / Ordering Code	Package	Marking	Related Links
IQE030N06NM5	PG-TSON-8-4	03006N5	-

# OptiMOS<sup>TM</sup> 5 Power-Transistor, 60 V



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### OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V **IQE030N06NM5**



## 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

B	0		Value	s		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	ID	- - -	-	137 97 21	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =60°C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	547	Α	T <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	153	mJ	$I_D$ =20 A, $R_{GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	107 2.5	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 °C/W <sup>2)</sup>
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol		Values		Linis	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	$R_{thJC}$	_	-	1.4	°C/W	-
Device on PCB, 6 cm² cooling area²)	R <sub>thJA</sub>	_	-	60	°C/W	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

## OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V IQE030N06NM5



## 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Danamatan	Comple ed	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=50\ \mu{\rm A}$
Zero gate voltage drain current	<b>I</b> <sub>DSS</sub>	-	0.5 10	1.0 100	μA	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	2.2 3.3	3.0 5.0	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A V <sub>GS</sub> =6 V, I <sub>D</sub> =5 A
Gate resistance	R <sub>G</sub>	-	0.9	-	Ω	-
Transconductance	$g_{fs}$	-	120	-	S	

 Table 5
 Dynamic characteristics

Parameter	Symbol	Values		Unit	Note / Test Condition	
	Symbol	Min.	Тур.	Max.	Onit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	2900	3800	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	600	780	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	37	65	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	10	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Rise time	t <sub>r</sub>	-	5.7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	18.8	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Fall time	t <sub>f</sub>	_	5.7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Parameter	Sumb al	Values			11	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	12.2	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	8.1	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	$Q_{\mathrm{gd}}$	-	6.8	10.2	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	10.9	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	39	49	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	4.2	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	35	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Qoss	-	42	56	nC	V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

## OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V IQE030N06NM5

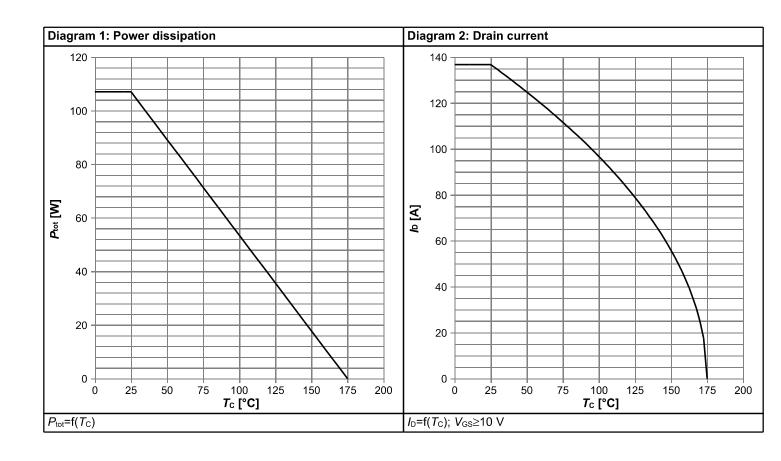


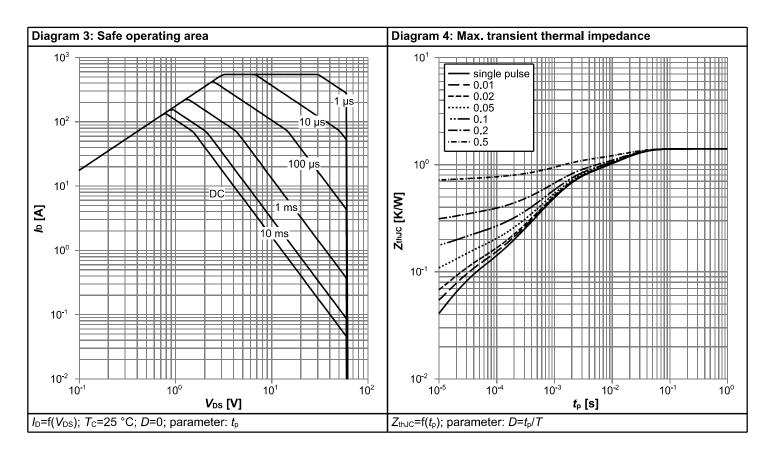
#### Table 7 Reverse diode

Davamatav	Comple of	Values			11:4	Note / Tool Occupier
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	72	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	547	Α	T <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.82	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	31	62	ns	V <sub>R</sub> =30 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs
Reverse recovery charge <sup>1)</sup>	Q <sub>rr</sub>	-	26	52	nC	V <sub>R</sub> =30 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

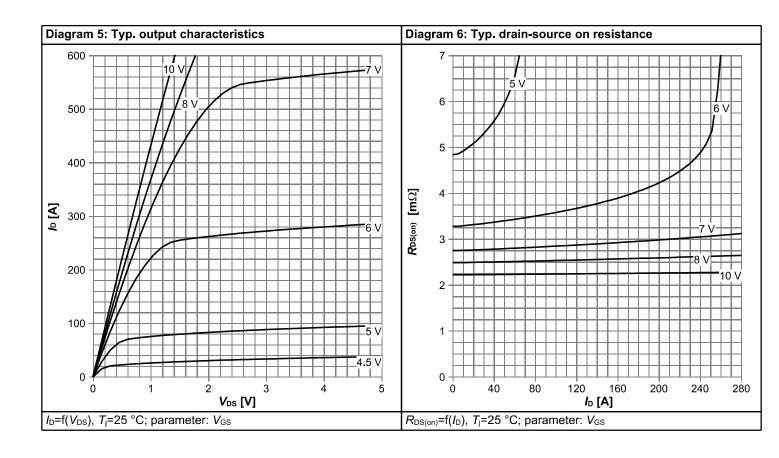


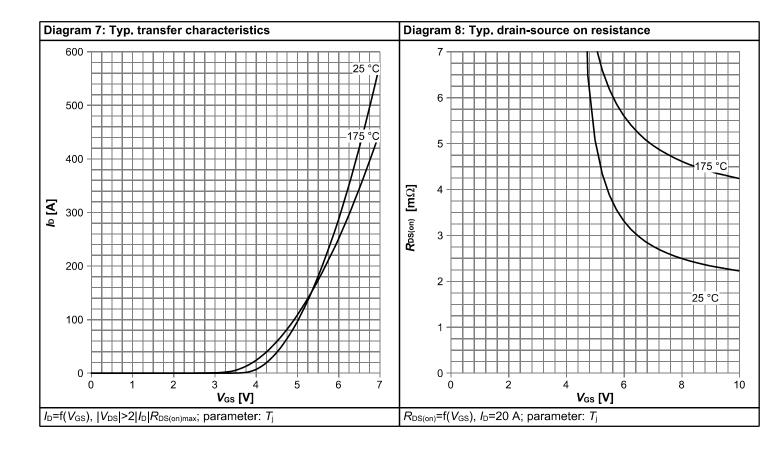
## 4 Electrical characteristics diagrams



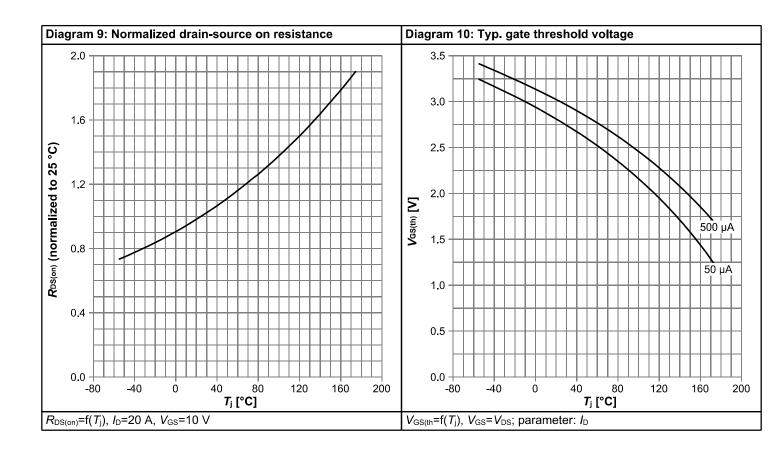


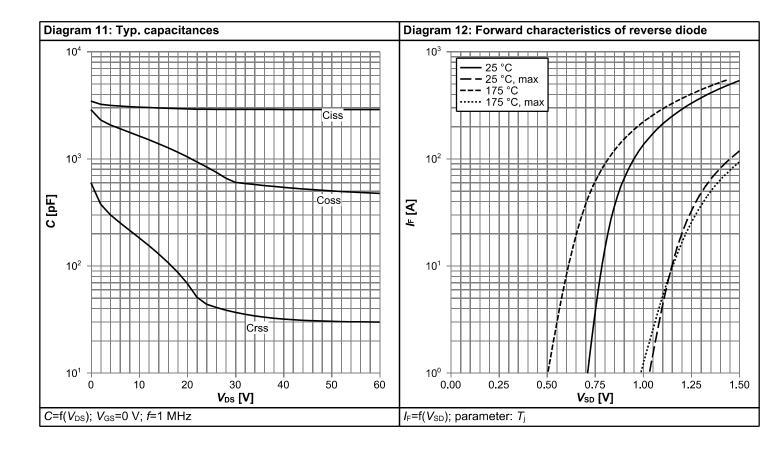




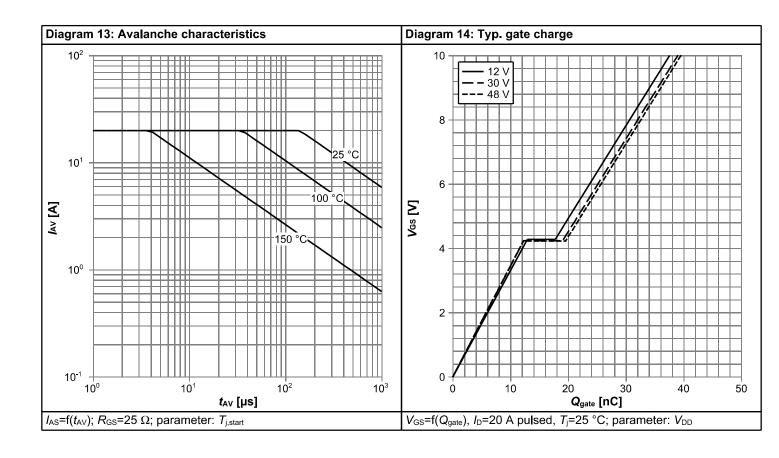


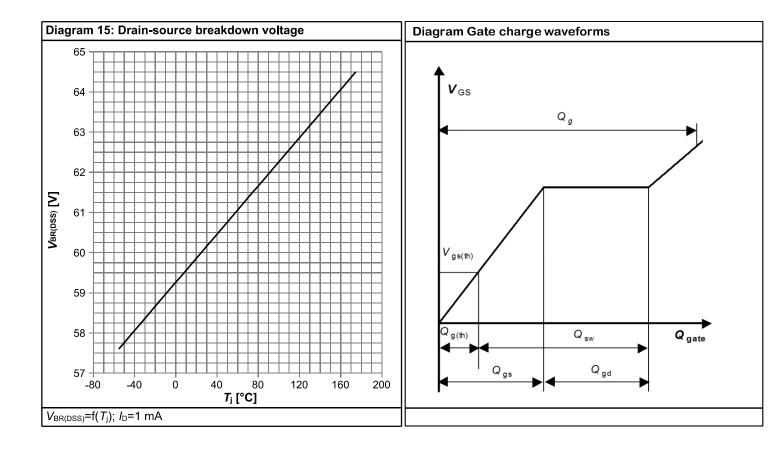






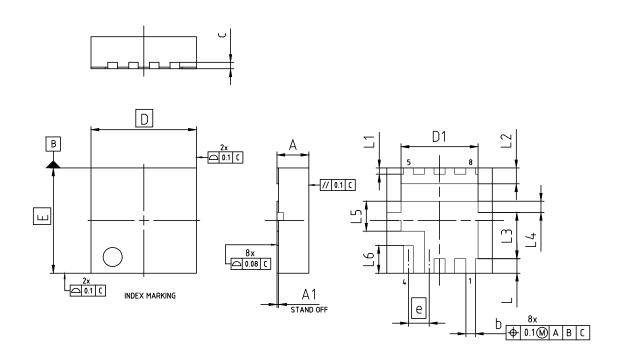








## 5 Package Outlines



DIMENSION	MILLIMETERS						
DIMENSION	MIN.	MAX.					
Α	=	1.10					
A1	=	0.05					
b	0.20	0.40					
С	0.3	20					
D	3.	30					
D1	2.31	2.51					
E	3.30						
е	0.65						
L	0.35	0.55					
L1	0.10	0.30					
L2	0.40	0.60					
L3	1.35 1.55						
L4	0.26 0.46						
L5	0.84 1.04						
L6	0.77	0.97					

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Figure 1 Outline PG-TSON-8-4, dimensions in mm



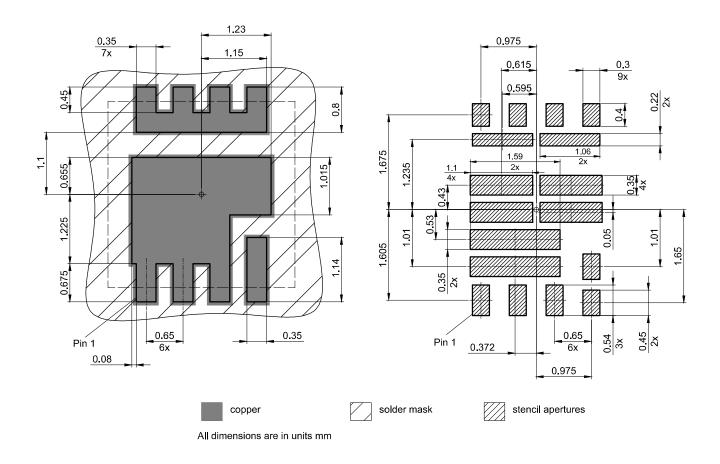


Figure 2 Outline Boardpad (PG-TSON-8-4)

## OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V IQE030N06NM5



#### **Revision History**

IQE030N06NM5

Revision: 2021-04-27, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-04-27	Release of final version

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